



PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

February 20, 2009

Applicants: Atsushi YABE et al
For: ELECTROLESS COPPER PLATING SOLUTION
Serial No.: 10/576 231 Group: 1792
Confirmation No.: 7188
Filed: April 14, 2006 Examiner: Bareford
International Application No.: PCT/JP2004/011327
International Filing Date: July 30, 2004
Atty. Docket No.: 4700.P0327US

Mail Stop RCE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RCE AMENDMENT

Sir:

In response to the Office Action dated October 20, 2008,
please amend the above-identified application as follows:

(Please see following pages.)